



**Meetings Quick Reference List**  
(as of 20 July 2009)

**I. MEETINGS FOR WHICH EDS ALWAYS PROVIDES SPONSORSHIP OR CO-SPONSORSHIP SUPPORT (Active Count = 13)**

MEETING NAME/ACRONYM	FREQUENCY/ LAST ATTENDANCE	NEXT OCCURRENCE(S)	EDS FINANCIAL SPONSORSHIP %	CO-SPONSOR(S) & FINANCIAL %
IEEE/SEMI <b>Advanced</b> Semiconductor Manufacturing Conference and Workshop (ASMC)	Annual/08 = 186	May 2010 - USA	25%	EDS (25%) CPMITS (25%) SEMI (50%)
		2009 - Europe <i>(cancelled for '09)</i>		
IEEE <b>Bipolar/BICMOS</b> Circuits and Technology Meeting (BCTM) (Alternates between the east and west coasts of the U.S. and Europe.)	Annual/06 = 200 3 year rotation	2010 - East Coast U.S.	100%	1986 - IEEE Twin Cities Section (50%), University of MN (50%)
		Oct. 2011 - West Coast U.S.	100%	1993-2000-IEEE MTTS (10%)
		10/12-14/09 - Italy	100%	2003 - LAAS/CNRS of France 2008 - EDS 100%
IEEE <b>Compound</b> Semiconductor IC Symposium (CSICS) <i>(formerly IEEE Gallium Arsenide Integrated Circuits Symposium (GaAs IC) co-located with BCTM in 2008)</i>	Annual/09 = 350	10/11-14/2009	100%	1993-2000 IEEE MTTS (10%)
IEEE International <b>Electron</b> Devices Meeting (IEDM)	Annual/08 = 1650	12/7-9/09 Baltimore, MD 12/6-8/2010 San Fran., CA	100%	N/A
IEEE International <b>Integrated</b> Reliability Workshop (IRW) (formerly - Wafer Level Reliability Workshop)	Annual/08 = 52	10/18-22/2009	50%	1991 - WLRWS (90%), Tech. Assoc. (10%) 1992-Present - IEEE RS (50%)
IEEE International <b>Interconnect</b> Technology Conference (IITC) (Meeting will rotate between U.S., Europe & Asia)	Annual/07 = 350	6/1-3/2009 - Japan 2010 - USA 2011 - Europe	100%	N/A
International Conference on <b>Microelectronics</b> (MIEL) {Chapter Meeting}	Biennial/08 = 130	5/16-19/2010	20%	1995 - Serbian Society for Microelectronics and Optoelectronics (50%), Serbian Council for Science & Technology (20%), University of NIS (Faculty Electrical Engineering (30%) 1997 - Univ. of Elec. Engrg. (Univ. of Nis) (60%) Serbia Ministry of Sci & Tech (20%) Yugoslav Ministry of Sci & Tech (20%) 2000-2006 - Faculty of Elec. Eng., Univ. of Nis (60%), Ministries of Sci & Tech. (10%), IEEE Yugoslavia Section (3.5%), IEEE ED/SSC Yugoslavia Chapter (1.5%) 2008-Present - University of NIS (70%), IEEE ED Serbia Chapter (5%), EDS (20%)
IEEE International <b>Memory</b> Workshop (IMW) (formerly the IEEE Non-Volatile Semiconductor Memory Workshop - NVSM) (Starting in 2009, the International Conference on Memory Technology and Design - ICMTD merged with the NVSM)	Annual/09 = 280 3 year rotation	May 2008 - Europe	100%	N/A
		May 10-14, 2009 - USA		
		5/16-19/2010 - Korea		
IEEE <b>Photovoltaic</b> Specialists Conference (PVSC)	Annual/09 = 1300	5/20-25/2010 - Honolulu, HI	100%	N/A
IEEE International Symposium on <b>Plasma &amp; Process-Induced Damage</b> (P2ID)	Annual/03 = 56	Conference terminated in 2003	100%	N/A
*IEEE International Conference on <b>Portable</b> Information Devices	Annual/08 = 100	Society support ended in 2008	20%	2007 - IEEE CPMITS, NTDC, BTS, ComSoc 2008 - IEEE VITS, EDS, CPMITS, SMCS (20%)
IEEE International <b>Reliability</b> Physics Symposium (IRPS)	Annual/08 = 460	4/26/-30/2009 - Japan	50%	IEEE RS (50%)
		5/2-6/2010 - USA		



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International Semiconductor Conference (CAS) (Chapter Meeting)	Annual/08 = 79	10/12-14/09	20%	1994 - ICCE of Romania, Ministry of Research and Tech. of Romania 1995 & 96 - ICCE, IEEE Romania Section, SOROS Foundation, Romanian Ministry of Research & Tech.(80%) 1998 - Romanian Ministry of Res. & Tech. (20%), SOROS Foundation (10%), IMT (50%) 1999 - Romanian Ministry of IMT (60%), Res. & Tech. (20%) 2000 - Present - IMT (70%), ANSTI (10%), EDS (20%)
IEEE Semiconductor Interface Specialists Conference (SISC)	Annual/07 =110	12/3-5/2009, Arlington, VA 12/2-4/2010 - San Diego, CA	100%	N/A
IEEE International SOI Conference	Annual/07 = 136	10/5-8/2009	100%	N/A



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(as of 20 July 2009)

**II. MEETINGS FOR WHICH EDS ALTERNATES SUPPORT BETWEEN 'SPONSORSHIP/CO-SPONSORSHIP' & 'TECHNICAL CO-SPONSORSHIP' (Active Count = 10)**

MEETING NAME/ACRONYM	FREQUENCY/ LAST ATTENDANCE	NEXT OCCURRENCE(S)	EDS FINANCIAL SPONSORSHIP %	CO-SPONSOR(S) & FINANCIAL %
IEEE International Conference on <b>Indium Phosphide and Related Materials (IPRM)</b>	Annual/06 = 300	5/1-14/09 - US	50%	IEEE LEOS (50%)
		5/31-6/4/10 - Japan	0%	95-04- JSAP of Japan
		2011 - Europe	50%	1993 LEOS (50%), SEE of France (50%) 1996 - ITG/VDE of Germany 2002 - JSAP (100%) 2005 & 2008 - LEOS (50%) & EDS (50%)
Intersociety Energy Conversion Engineering Conference (IECEC)	Annual/02 = 213	<b>Support Ended in 2003</b>	0%	ANS, SAE, AIAA, ASME, AIChE - Alternate each year (100%). ACS withdrew as sponsor, effective 1995
				1989 - IEEE AES (45.6%), IEEE NCAC (8.8%) 1996 - IEEE AES (17%), IEEE NCAC (1%)
IEEE International Conference on <b>Microelectronic Test Structures (ICMTS)</b>	Annual/08 = 110	3/22-25/2010 - Japan	0%	APEEIE
		2011 - Europe	0%	2005 - Katholieke Univ. Leuven 2008 - EDS (100%)
		2012 - U.S.	100%	N/A
IEEE World Conference on <b>Photovoltaic Energy Conversion (WCPEC)</b>	Every 4 years/06= 1,426	2010 - Europe or Asia Joint w/ PVSC, PVSEC & PSEC	100%	1998 - European Commission 2003 - PVSC Organizing Committee 2005 - EDS (100%)
IEEE International Symposium on <b>Power Semiconductor Devices and Integrated Circuits (ISPSD)</b>	Annual/07 = 284	6/6-6/10/10 - Japan	0%	IEE of Japan
		2011 - US	100%	N/A
		2012 - Europe	0%	1994 - Swiss Federal Inst 1997 - VDE 2000 - LAAS 2003 - UDC (80%), UK EPSRC (20%)
IEEE International Symposium on <b>Semiconductor Manufacturing (ISSM)</b> <i>(merged with ASMC starting in 2009)</i>	Annual/07 = 236		50%	1993 - 100% 1995 - Present CPMT (50%)
			0%	UCS of Japan
IEEE <b>Silicon Nanoelectronics Workshop (SNW)</b>	Annual/08 = 146	2009 - Japan	0%	JSAP of Japan
		June 2010 - US	100%	N/A
IEEE International Workshop on <b>Statistical Methodology for VLSI Design and Fabrication (IWSM)</b>	Annual/98 = 49	<b>Workshop Discontinued 11/01/02</b>	0%	JSAP of Japan
			100%	N/A



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IEEE TRANSDUCERS - International Conference on Solid-State Sensors, Actuators and Microsystems (TRANSDUCERS)	Biennial/09 = 1200	2013 - Europe	0%	1995 - Foundation for Sensor and Actuator Technology of Sweden 2001 - DFG of Germany 2007 - CEA Minattec
		6/14-6/18/09 - U.S.	100%	N/A
		2011 - Asia	0%	1987 - IEE of Japan 1993 - IEE of Japan, Japan Science Foundation 1999 - N/A 2005 - KSS
IEEE International <b>Vacuum</b> Electron Sources Conference (IVESC)  (2 Year rotation between U.S., Europe & Asia) (For 2006 occurrence, co-located with IVEC)	Biennial/06 = 400	2014 - Europe	0%	2002 - Russian Ministry of Industry (25%) Russian Fund of Fundamental Research (25%) Government of Saratov Region, Russia (25%) Enterprises of Electron Industry (15%) IEEE MTT/ED/AP/CPMT Saratov-Penza Chapter (10%)
		2010 - Asia	0%	1998 - IUVESTA, Vacuum Society of Japan, JSPS 2004 - CIE China (100%)
		2012 - U.S.	100%	N/A
IEEE International <b>Vacuum</b> Electronics Conference (IVEC)  (For 2006 occurrence, co-located with IVESC)	Annual/06 = 400	2011 - U.S.	100%	N/A
		2010 - Asia	100%	N/A
		4/28-30/09 - Europe	0%	2001 - ESTEC of Norway 2005 - ESA of the Netherlands 2009 - ESA of the Netherlands
IEEE International <b>Vacuum</b> Nanoelectronics Conference (IVNC) (formerly - Int'l Vac. Microelectronics Conf. - IVMC)	Annual/08 = 368	5/18-20/2010 - USA	100%	2007 - Electron Devices Society
			0%	2001 - Univ of California
		2/21-22/2011 - India	100%	1989 - IOP of UK 1992 - Austrian Ministry of Science and Research (50%), Vienna Tourist Board, Austria (50%) 1994 - Societe Francaise du Vide of Franceb 2002 - University of Lyon 2005 - Oxford University
		2012 - Europe	0%	1991 - JSAP of Japan 1997 - Electronic Display Industrial Research Association for Korea 2003 - JSPS 2006 - SYU - Sun Yat-sen University (95%), NSFC - Ministry of Education of China (5%)
IEEE Symposium on VLSI Technology (No std. acronym)	Annual/08 = 498	June 2011 - Japan	0%	JSAP of Japan
		6/15-17/2010 - Honolulu, HI	100%	N/A

## TOTAL ACTIVE EDS MEETINGS

as of 2 June 2009

SUPPORT TYPE	COUNT
Sponsorship/Co-Sponsorship *	23
Technical Co-Sponsorship **	140
Cooperation	0
<b>Total</b>	<b>163</b>

\* Includes 11 meetings for which EDS alternates support between 'sponsorship/co-sponsorship' and 'technical co-sponsorship'

\*\* Includes 53 meetings fully/partially organized by ED Chapters

Sponsor Name	Sponsor Acronym	Sponsor Country
17th International Photovoltaic Science and Engineering Conference	PVSEC-17	Japan
A.S. Popov Russin Scien. & Tech. Society for Radio Eng., Elec. & Telecom	ASPOPOV	Russia
Academy of Scientific Research & Tech.	ASRT	Egypt
ACI SIG on Design Automation	ACI SIG	India
ACM - SIGDA	ACM	USA
ACM/SIGNA	ACM/SIGNA	USA
ADERA Services	ADERA	France
Administration of Tomsk Region	ATR	Russia
Aerospace Electronic Systems Society	AES	USA
AES/AP/ED/EMB/MTT/GRS/LEO/NPS East Ukraine Joint Chapter	East UK	Ukraine
Alexandria University	AU	Egypt
All India Council	AIC	India
American Chemical Society Snake River Section	ACS	USA
American Society of Mechanical Engineers	ASME	USA
American University of Beirut	AUB	Lebanon
American Vacuum Society	AVS	USA
Applied Computational Research Society	ACRS	USA
ARC Australian Research Network for Advanced Materials	ARNAM	Australia
Assoc. for Promotion of Electrical, Electronic & Information Engrg.	APEEIE	Japan
Association for Computing Machinery Special Interest Group on Software	AFCMS	USA
ATMI Inc.	ATMI	USA
Atomic Energy Authority	AEA	Egypt
Atomic Weapons Establishment	AWE	United Kingdom
Australian Research Council Nanotechnology Network	ARCNN	Australia
BCTM2006 Foundation	BCTM	The Netherlands
Beijing Jiaotong University	BJU	China
Belarus State University of informatics and Radioelectronics	Minsk	Ukraine
Boise State University	BSU	USA
Brazilian Computer Society	BCS	Brazil
Brazilian Microelectronics Society	Brazil	Brazil
Brazilian Research Funding Agency	BRFA	Brazil
BSUIR	BSUIR	Ukraine
Budapest University of Technology and Economics	BUTE	Hungary
Catalan Regional Government	CRG	Spain
CESPA - CNR	CNR	Italy
Chinese Academy of Science	CAOS	China
Chinese Institute of Electronics	CIE	China
Chinese University of Hong Kong	CUHK	China
Chipidea Microelectronics	CM	Portugal

Sponsor Name	Sponsor Acronym	Sponsor Country
CINVESTAV-IPN	CINVESTAV	Mexico
CNRS, National Agency for Scientific Research	CNRS	France
Components, Packaging & Manufacturing Technology Society	CPMTS	USA
Coordinated Accelerator Research in Europe Project	CARE	Poland
Cornell University	UCN	USA
CPMT/ED/R/Singapore	EDR	Singapore
CRDF (REC-006)	CRDF	Russia
Croucher Foundation	CF	China
CSIC	CSIC	Spain
Czech Noise Research Lab	CNRL	Czech Republic
DARPA	DARPA	USA
Delft Institute of Microelectronics and Submicronotechnology	DIMES	The Netherlands
Department of Energy	DOE	USA
Department of Innovation, Industry and Regional Development	DIIRD	Australia
Department of Microelectronics & Computer Science, Tech Univ of Lodz	UN Lodz	Poland
Device Research Conference Organization	DRC	USA
Dnepropetrovsk National University	DNU	Ukraine
Dod of the USA	DoD	USA
Dutch Technology Foundation	DTF	The Netherlands
Ecole Mohammadia	ECOLE	Morocco
ECS Electronic Division	ECSED	USA
ED Beijing	ED Beijing	China
ED Hong Kong	ED Hong	Hong Kong
ED Israel Chapter	ED Israel	Israel
ED Kansai Chapter	ED Kansai	Japan
ED Malaysia - IEEE ED Malaysia Chapter	Malaysia	Malaysia
ED Mexico Chapter	ED Mexico	Mexico
ED Republic of Georgia	ED Georgia	Ukraine
ED Spain Chapter	ED Spain	Spain
ED Taipei Chapter	ED Taipei	Taiwan
ED Tsinghua University Student Branch	TUSB	China
ED West Ukraine Chapter	ED Ukraine	Ukraine
Egyptian Academy of Scientific Research & Technology	EASRT	Egypt
Electrochemical Society	ECS	USA
Electron Devices Society	EDS	USA
Electronic Industries Association/JEDEC	EIA/JEDEC	USA
Electronics Computer Society	ELCS	Brazil
Electronics Industry Association	EIA	USA
Electronics Society, IEICE, Japan	IEICE	Japan
ENEA CR Portia	ENEA	Italy
Enterprises of Electron Industry of Russian & Other countries	EEIROC	Russia
EPSRC	EPSRC	United Kingdom
ESD Association	ESD	USA
ESTEC Conference Bureau	ESTEC	Norway
EU Growth Network aSiNet	EUNA	Portugal
European Commission	IST	France
European Commission funded Network of Excellence in Nanodevices	NANOSIL	Germany
European Commission Project "SINANO"	SINANO	Ukraine
European Growth Program of the 5th Framework Program	EGP	Slovak Republic
European Microwave Association	EuMA	USA
European Space Agency	ESA	The Netherlands
European Union	EU	Slovak Republic
Faculty of Elec. Eng., Nis	FEE Nis	Serbia & Montenegro
Faculty of Electronic Enigenering Univ of Nis	Nis	Yugoslavia
Federal Agency for Atomic Energy of the Russian Federation	FAAERF	Russia
Federal University of Santa Catarine	FUSC	Brazil

Sponsor Name	Sponsor Acronym	Sponsor Country
FhG IIS-B	FhG	Germany
Florida West Coast Section	FWC	USA
Forschungszentrum Julich Startseite	FJS	Germany
Fraunhofer Institute for Applied Solid State Physics Freiburg	FIASSPF	Switzerland
Freescale	FRE	USA
French Ministries of Education and Defense	FMED	France
French University in Cairo	FUC	Canada
Fudan University	Fudan	China
Gallium Arsenide Application Symposium Committee	GAAS	USA
German National Science Foundation	DFG	Germany
German Research Society	DFC	Germany
Golomt Bank of Mongolia	BOM	Mongolia
Government of Saratove Region, Russia	GSRR	Russia
Graduate School of Engineering, Osaka University	OU	Japan
Hellas (Forth) of Greece	HELLAS	Greece
HITEN	HITEN	Norway
Hong Kong Section ED/SSC Joint Chapter	HK	China
IBM	IBM	USA
IEE of Japan	IEE of Jap	Japan
IEEE Antennas & Propagation Society	APS	USA
IEEE Antennas and Propagation Society	AP	USA
IEEE Beijing Section	BEI	USA
IEEE Benelux Chapter	Benelux	France
IEEE Boise Section	Boise Sect	USA
IEEE Bombay Section	IBS	India
IEEE Broadcast Technology Society	BTS	USA
IEEE Byisk Student Branch Chapter	Byisk	Russia
IEEE CAS/ED North Jersey Chapter	CAS/ED NJ	USA
IEEE CASS	CASS	USA
IEEE Circuits and Systems	CAS	USA
IEEE Communications Society	ComSoc	USA
IEEE Computer Society	CS	USA
IEEE Council on Electronic Design Automation	CEDA	USA
IEEE Dielectrics and Electrical Insulation Society	DEIS	USA
IEEE East Ukraine Joint Chapter	E Ukraine	Ukraine
IEEE ED Boise Chapter	ED Boise	USA
IEEE ED Malaysia Section	ED Malaysi	Malaysia
IEEE ED Society	ED	USA
IEEE ED/MTT France Chapter	France	France
IEEE ED/SSC Seoul Chapter	Seoul	Korea
IEEE ED/SSC Serbia & Montenegro	ED Serbia	Serbia & Montenegro
IEEE Electromagnetic Society	ES	USA
IEEE Engineering in Medicine and Biology Society	EMBS	USA
IEEE Japan Council	ED Japan	Japan
IEEE MTT/ED/AP/CPMT/Saratov-Penza Chapter	IEEE	Russia
IEEE Nanotechnology Council	NANO	USA
IEEE New Technology Directions Committee	TAB NTDC	USA
IEEE Novosibirsk Chapter	Novosibirs	Russia
IEEE Princeton Section	Princeton	USA
IEEE R10 - Region 10	R10	India
IEEE Region 5	IEEE R5	USA
IEEE Region 8	IEEE R8	USA
IEEE Rochester Section	Rochester	USA
IEEE Sensors Council	Sensors	USA
IEEE Serbia & Montenegro	Serbia	Serbia & Montenegro
IEEE Siberian Section	SiberiaSec	Russia

Sponsor Name	Sponsor Acronym	Sponsor Country
IEEE Singapore Section	Singapore	Singapore
IEEE Systems, Man and Cybernetics Society	SMCS	USA
IEEE TAB New Technology Directions Committee	NTDC	USA
IEEE Vehicular Technology Society	VTS	USA
IEEE-USA	IEEE USA	USA
IEEE-Venezuela CAS/ED/PEL Joint Chapter	Venezuela	Venezuela
IEIIT-CNR	IEIIT	Italy
IM Austria	IMA	Austria
IMEC	IMEC	Belgium
Indian Statistical Institute	ISI	India
Industrial Electronics Society	IES	USA
Industrial Technology Research Institute Ministry of Economic Affairs, ROC	ITRI	Taiwan
Insittuto Nacional de Astrofisica	INAOE	Mexico
Institute for Photonic Technology	IPHT	Germany
Institute for Problems of Electrophysics	IPE	Russia
Institute of Applied Problems of Mechanics and Mathematics	IAPMM	Ukraine
Institute of Electrical Engineering SAS	IEE SAS	Slovak Republic







